

Semiconductor & Display Trends

November 2016

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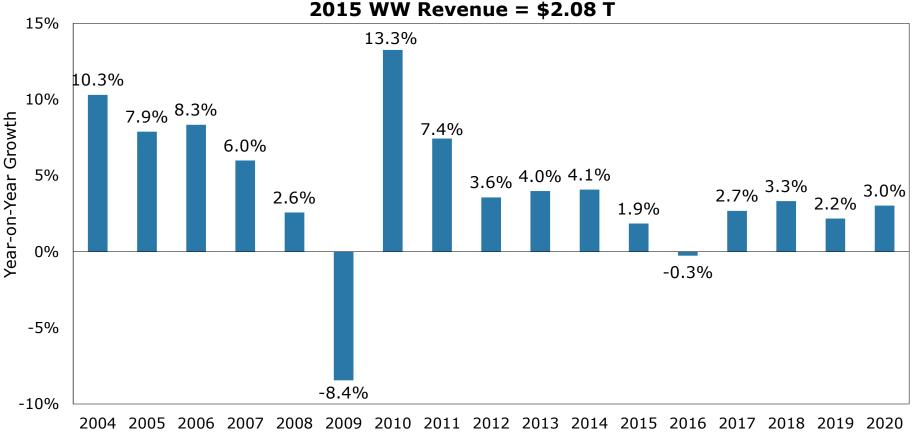
Electronics & semiconductor forecast outlook

The Start of a New Cycle



Electronics market – Growth goes negative for 2nd time in 14 years

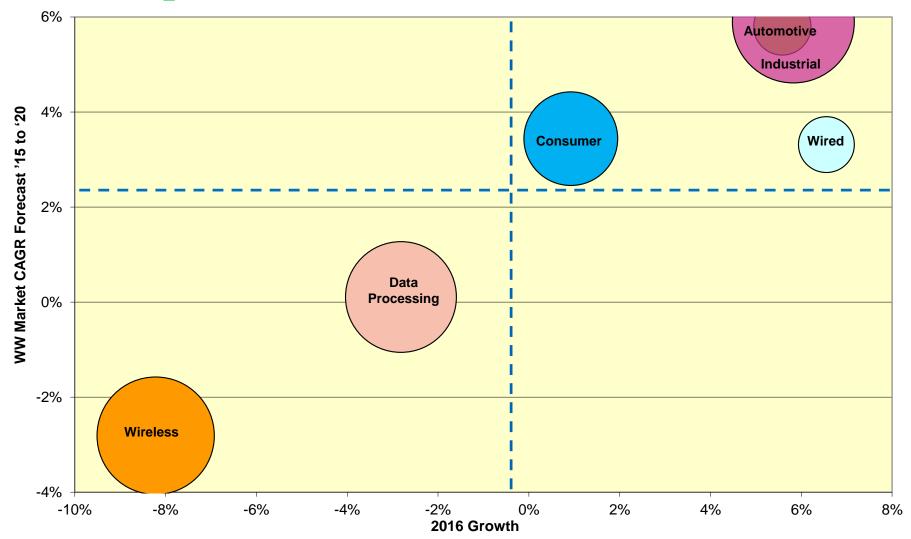
- Five year CAGR = 2.2%
- Industrial Electronics leads growth followed by Automotive, Consumer & Wired Comm
- Industrial Electronics passed Data Processing as largest market in 2012; Wireless followed in 2013
 Global Electronic Systems Revenue



Source – IHS Application Market Forecast Q3 2016



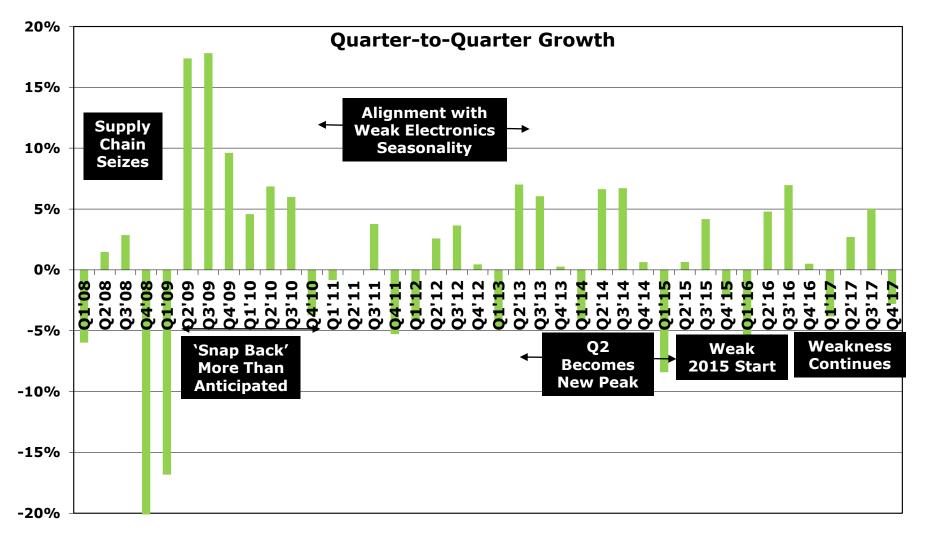
Electronics growth weighed down by Wireless & Data Processing





Quarterly semiconductor forecast

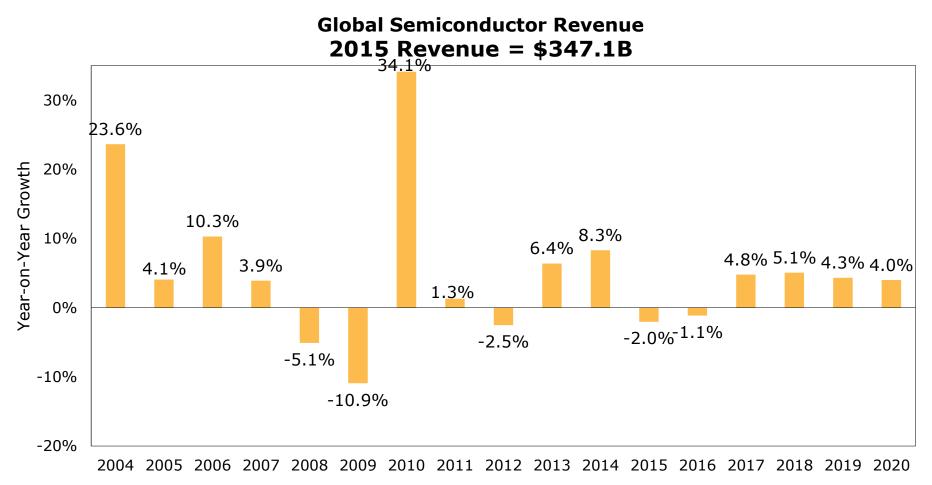
Q2 & Q3 2016 surge to solid growth; Boost full year to only -1.1% decline





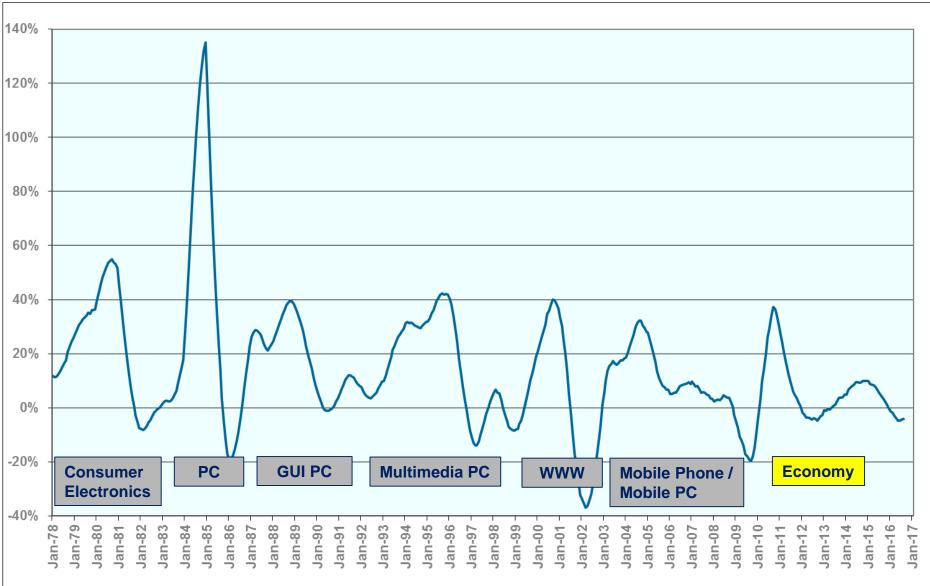
Annual semiconductor outlook

- Semiconductor market growth outlook Next four years challenging
 - June 2016 begins tenth semiconductor industry cycle mid-single digit growth
 - Long-term outlook sees five-year CAGR of only 3.4%





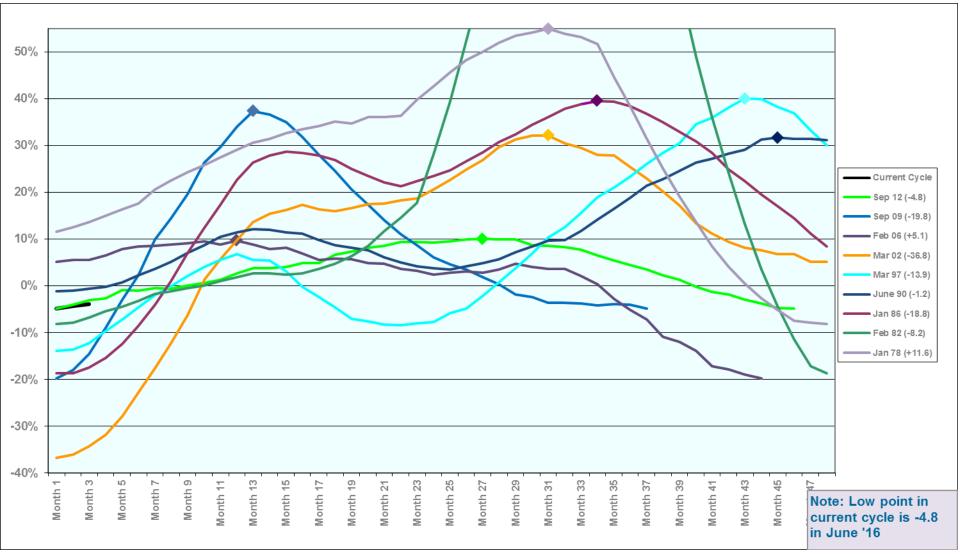
Historical 12 month moving average





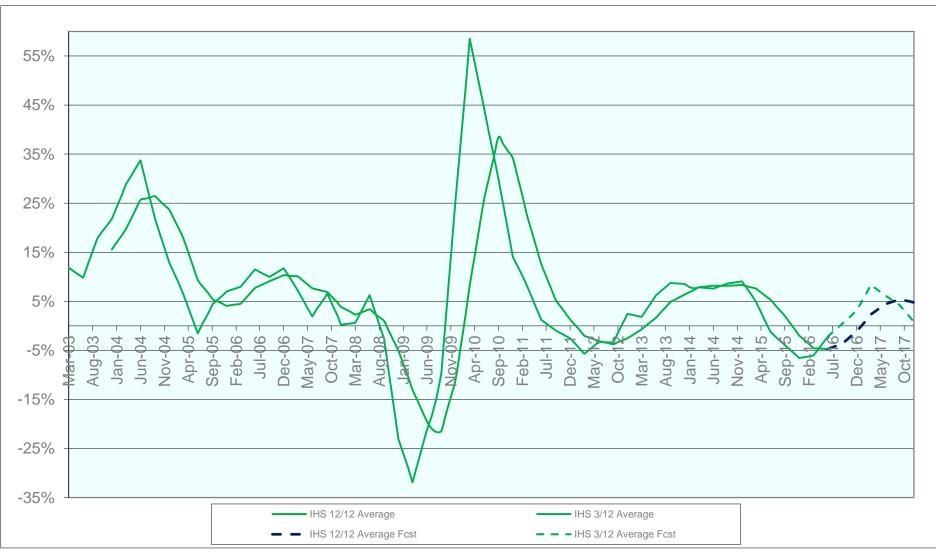
June 2016 – Start of the tenth semiconductor cycle

Most cycles last roughly four years



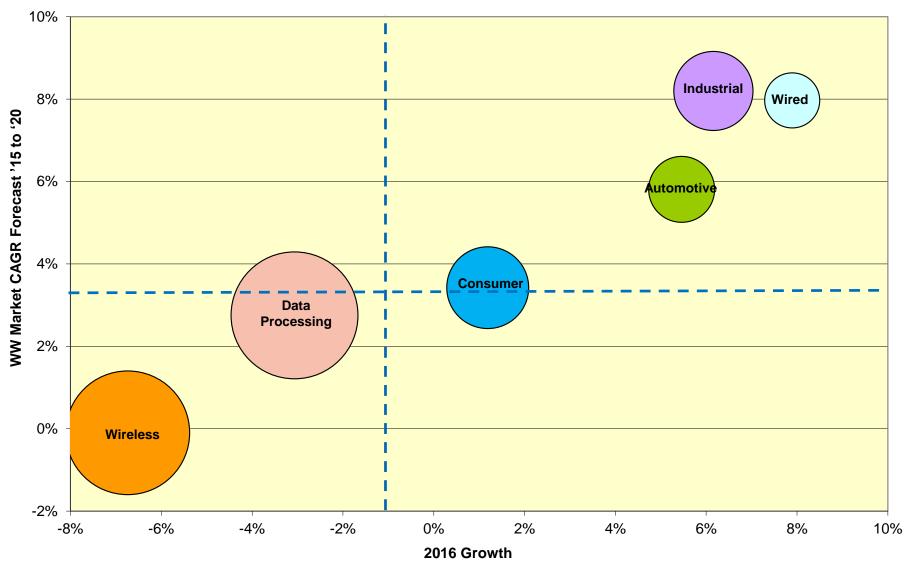


3/12 and 12/12 moving averages



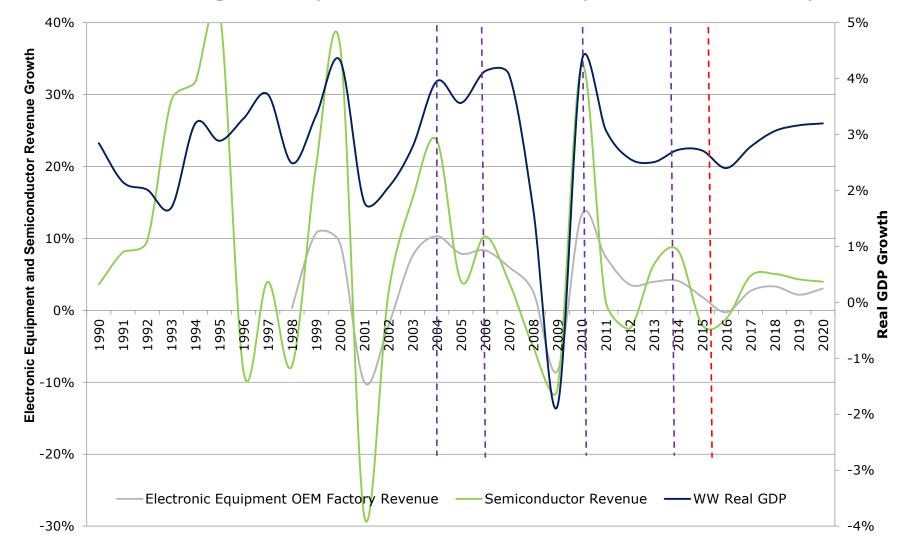


New semiconductor growth drivers for next 5 years



Source - IHS Application Market Forecast Q3 2016

Historic alignment between economy and electronics Semiconductor growth profile continues to predict accurately



🕈 IHS Markit

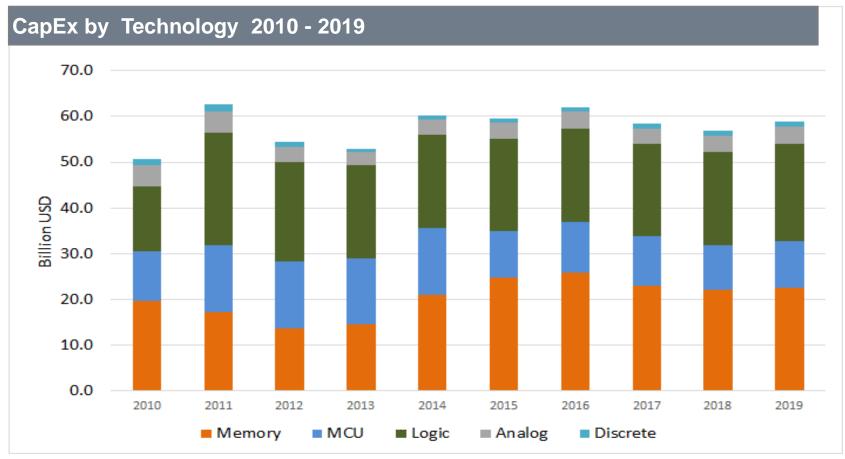


Semiconductor manufacturing trends



Capital expenditure provide verification for long-term growth opportunities as well as a technology roadmap

• Expenditures supporting Logic (Foundry) and Memory continue to fuel long-term industry revenue growth



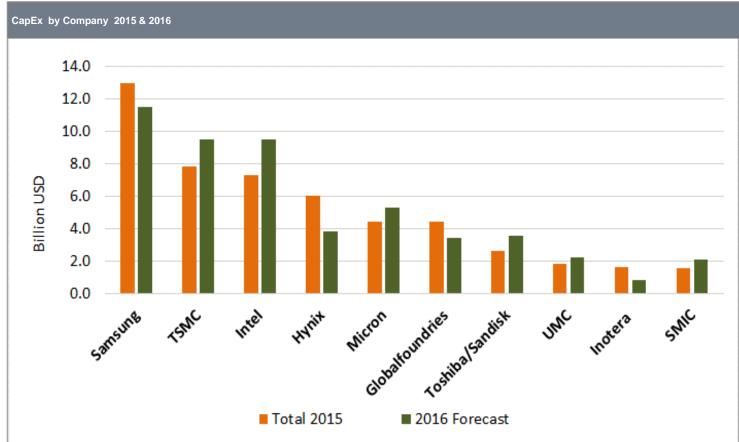
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2016 capital expenditure forecast by company

- Expenditures for capital are focused on next generation technology and expansions in China
 - > Samsung, TSMC, Intel, Globalfoundries, UMC and SMIC are all focused on adding capacity in China





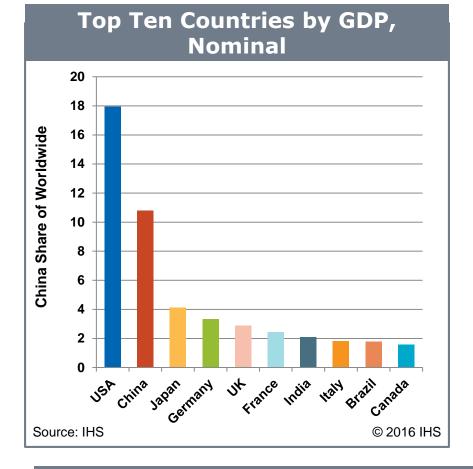
Technology migrations drive 2nd half revenue

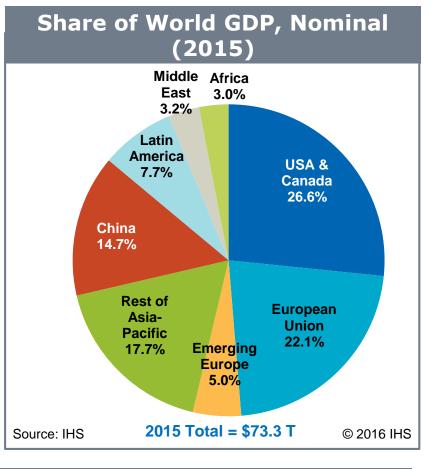


- Foundry revenue is driven by demand for advanced technology supporting Handsets, Graphics and computing
 - >28 nanometer Apple, MediaTek, Qualcomm, Xilinx, Nvidia, AMD, Huawei, HiSilicon, Spreadtrum
 - >20 nanometer Apple, Qualcomm, Xilinx
 - >16/14 nanometer Apple, Qualcomm, MediaTek, Xilinx, Nvidia, AMD, IBM, HiSilicon, Spreadtrum
 - >10 nanometer Apple, Qualcomm, MediaTek, HiSilicon
 - >7 nanometer Apple, Qualcomm, MediaTek, Xilinx, HiSilicon, Lenovo, IBM, AMD



China Has Become a Global Economic Powerhouse

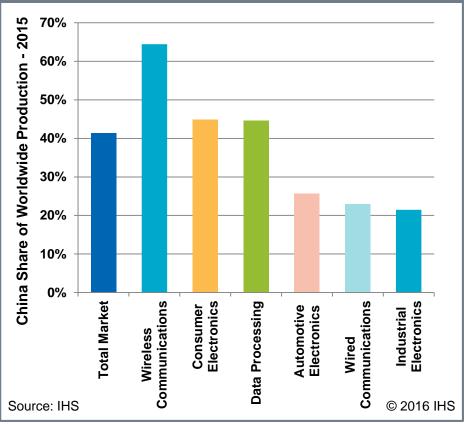




China has the largest economy outside of the US and is a leader in its region



China Dominates Production of Electronics: Local markets growing to complement exports



China's Share of WW Production

Production Trends

- Workforce, infrastructure & technology have driven highquality / low-cost production centers and China dominance of electronics production
 - Foxconn is the modern driver of the "company town / city" in China
- Other countries such as the US have lost critical skills/abilities to compete in the world of manufacturing in many key sectors

Consumer and Mobile Electronics Production Revolve around China



China – Development of a domestic supply chain

- Development of a semiconductor industry began with Project 909 in 2000
 - > Semiconductor companies that were state owned were privatized
 - >HHNEC, SGNEC, ASMC were the initial companies founded as JV's with multinational companies
- Technology development was limited due to US and Taiwan laws
- SMIC became the first company to successfully develop advanced technology using 300mm wafers
 - >SMIC formed a JV with Elpida Memory in order to manufacture DRAM
- China's goal: "Made in China Policy 2025"

>40% self-sufficient by 2020 and 70% self-sufficient by 2025



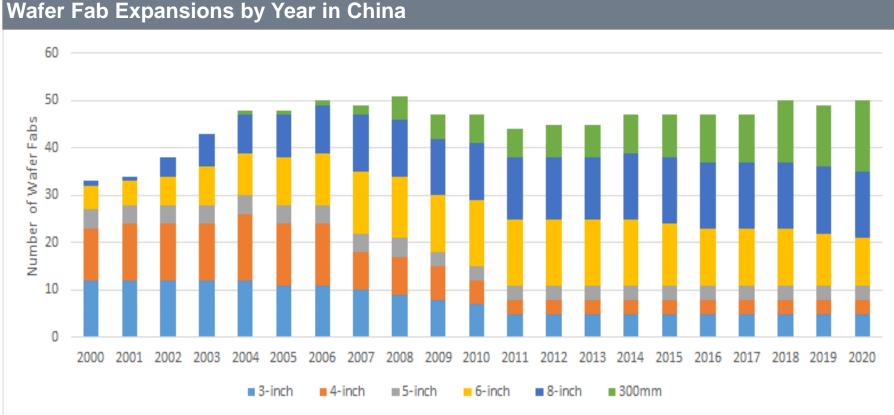
China – Global challenges facing China

- China is the worlds largest purchaser of semiconductors accounting for more than 55% of global consumption
 - > China is also the worlds largest exporter of electronics systems
- China is aggressively adding capacity in order to manufacture components to reduce the volume of semiconductors imported
- Semiconductor technology manufactured in China's domestic fabs remains 3 generations the market leaders
 - >Advanced technology accounts for more than half of China's semiconductor imports



Manufacturing expansions in China

- Expansion in Chinese wafer fabs is focused on 300 mm
 - >Technology deployment targets ranges from n-1 to legacy "More than Moore"

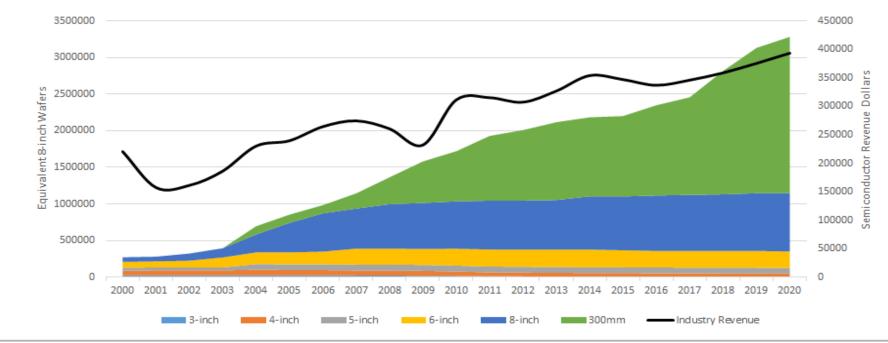




Chinese wafer capacity expansions will outpace shortterm demand

- Global semiconductor industry continues in a slow growth period through 2020 and possibly 2022
 - > Domestic demand must increase substantially in order to fill fab capacity beyond 2017

Forecasted Capacity Expansions within China and Global Semiconductor Industry Revenue



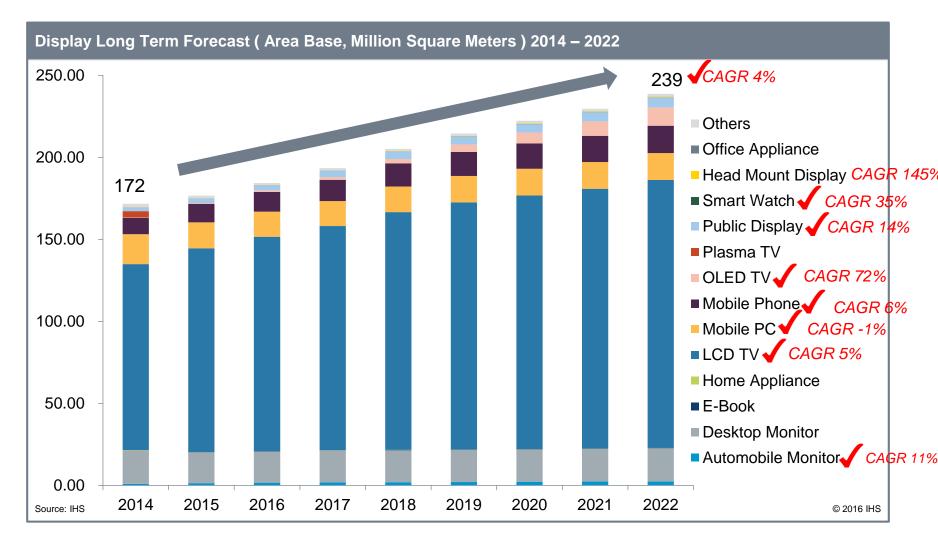
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Displays



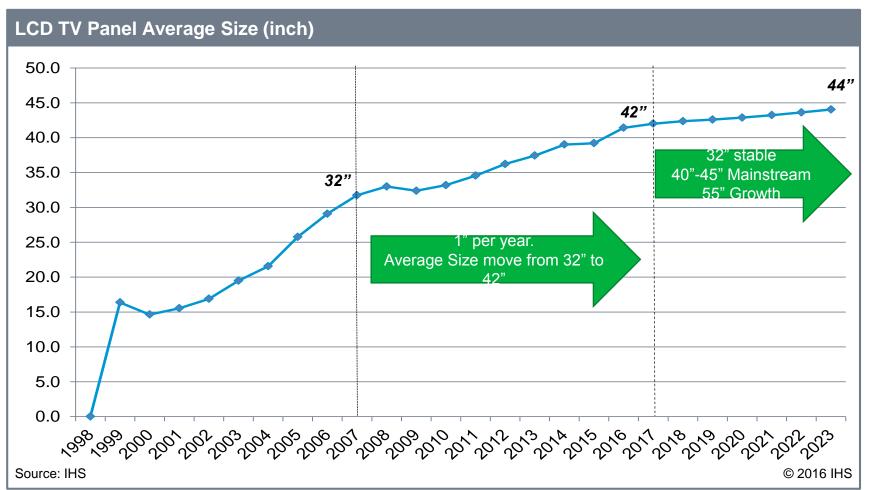
Demand Driven By TV Area & New Applications





Growth engine: Demand for larger size TV

- Big size jump within these years : 39.2"@2015, 41.4"@2016, 42"@2017
- 2016 : 4x" segment surpass 3x" segment. 2018: 6x" segment surpass 5%.





Possible restructure/shutdown of fabs in 2016-2017

• Struggling financial issues, low utilization, and low efficiency push panel makers to shut down fabs.

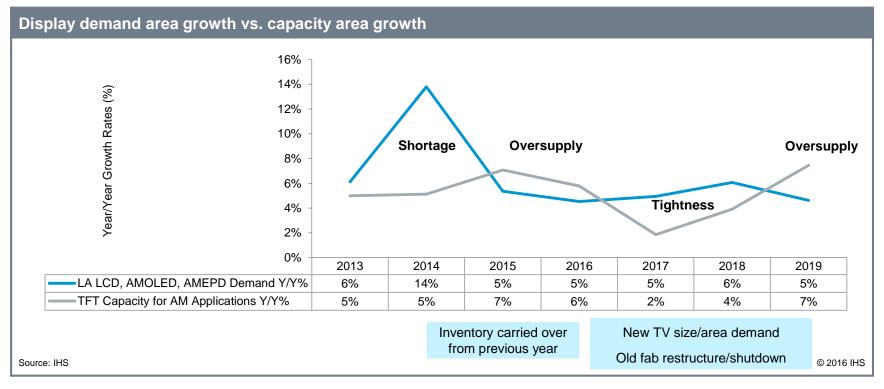
Panel Maker	Fab	Gen/Glass Size	Original Capacity	Tech.	Utilization now	Products	Ramp-up year	Depreciated Year	Original EOL Year
Samsung	L6	Gen 5	120K/M	a-Si	70-80%	Mobile	2003	2009	2018
Display	L7-1	Gen 7	155K/M	a-Si	95%	40" TV	2005	2011	2018
	L3C	Gen 3.25	60K/M	a-Si	35%	Mobile	1999	2006	2017
	L4A	Gen 3.5	25K/M+ 35K/M Touch	a-Si	50-60%	Mobile, Touch	2001	2008	2017
AUO	L3D	Gen 3.25	50K/M + 15K/M LTPS	a-Si	0%	Mobile, Touch	2001	2008	2015/End
	L5A	Gen 5	50K/M	a-Si	60-70%	Mobile, NB	2003	2009	
	L5D	Gen 5	75K/M	a-Si	50-60%	Mobile, NB	2003	2011	
	Т0	Gen 4	20K/M	a-Si+EPD	50%	Mobile	2004	2009	2017
	T1	Gen 5	60K/M	a-Si	60%	Mobile	2004	2010	2018
Innolux	Fab1	Gen 3.25	70K/M	a-Si	60-65%	Mobile	1999	2005	2018
	Fab2	Gen 3.5	85K/M	a-Si	45-50%	Mobile	2001	2007	2018
	Fab3	Gen 5	145K/M	a-Si	85%	Mobile, NB	2003	2010	
	P2	Gen 3.25	85K/M	a-Si	52%	Mobile, NB	1997	2004	
	P3	Gen 3.5	92K/M	a-Si	50%	Mobile, NB	2000	2004	2018
LG Display	P4	Gen 5	150K/M	a-Si	65%	Mobile, NB	2002	2008	2019
	P5	Gen 5	100K/M	a-Si	62%	Mobile, NB	2002	2007	2018
BOE	B1	Gen 5	75K/M	a-Si	0%	Shift to MEMS	2004	2012	2016
BOE	B2	Gen 4	45K/M	a-Si	Stop	Mobile	2008	2016	2016
	T2	Gen 3.5	73K/M	a-Si	<20%	Mobile	2001	2007	2018
CPT	T1	Gen 3	35K/M	a-Si	<50%	Mobile	1999	2006	
Sharp	Taki No.2C	Gen 3.5	45K/M	a-Si	<45%	Auto, Mobile	2000	2005	
	Taki CGS B	Gen 4	95K/M	a-Si, In-Cell	<50%	Mobile	2003	2010	2018
JDI	Mobara V3 LTPS	Gen 4	40K/M	LTPS	<50%	Mobile	2002	2012	2016
	STL Higashiura #1& #2	Gen 3.25	36K/M	LTPS+OLED	<50%	Mobile	1999	2007	2017

Source: IHS



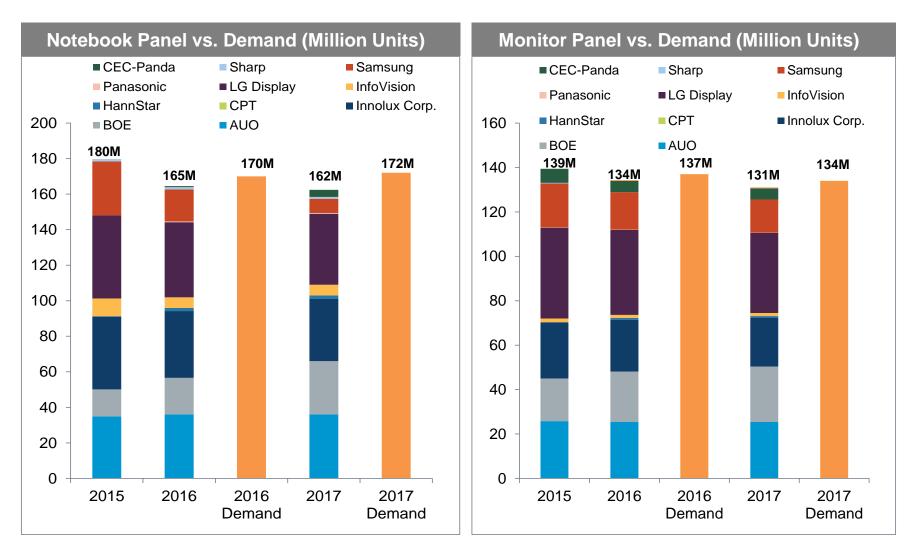
Capacity Area Growth vs. Demand

- 1H'16 : Oversupply. 2H'16 : Tightness. The panel price increase in 2H'16 has somehow reflected the tightness in '17 and '18.
- 2017 and 2018 will be tight due to fab restructure and LCD TV area growth. To cope with the tightness, panel makers might have to pull in new fab construction schedules.
- In reality, the LCD TV demand will be influenced by the panel price increase in 2017-2018.



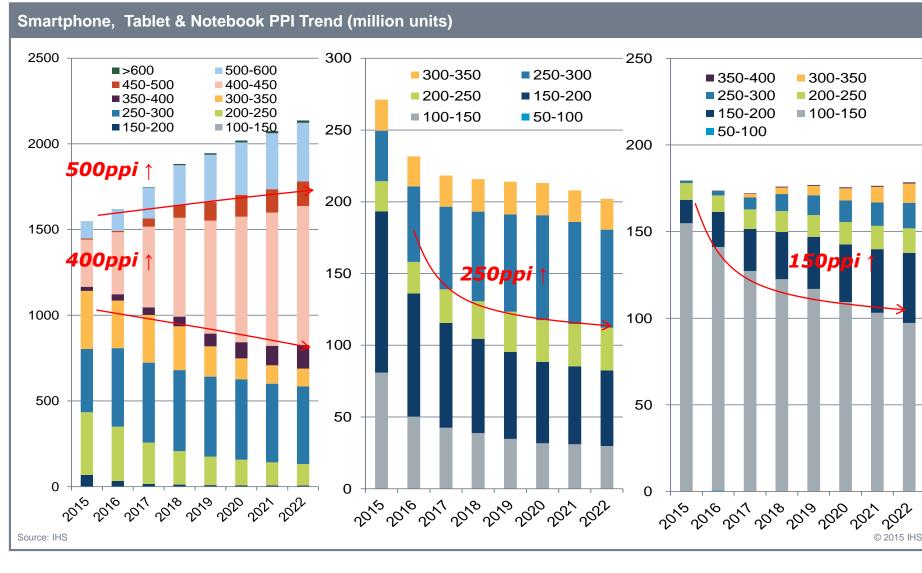


NB and Monitor Panel Price Stabilize due to low supply





Growth engine: Higher resolution





Model Name	Facebook Oculus Rift	HTC Vive Pre	Sony PlayStation VR	FOVE FOVE VR	Starbreeze StarVR
Photos	Image credit: Oculus	Image credit: HTC	Image credit: Sony	Image credit: FOVE	Image credit: Starbreeze
Start Price	\$599	\$799	\$399	\$500	TBC
Launch Time	Mar'16	Apr'16	Oct'16	Q1'16	TBC (Acer)
Display pieces	2 pcs OLED	2 pcs OLED	2 pcs OLED	1pcs LCD	2 pcs LCD
Display	2 pcs 1080x1200 OLED 90mm (3.54'), 456 ppi	2 pcs 1080x1200 OLED 92mm (3.62'), 447 ppi	2 pcs 960x1080 ,3.x" = 1pics of 5.7" , each 960x1080, 387ppi	1pcs of 5.7" 2560 x 1440 LCD	2pcs of 5.5" (2160x1440) Total 5120 x 1440 LCD 472 ppi
Refresh Rate	90Hz	90Hz	120Hz	60Hz	90Hz

editioning propidly of the American prototype		VR display performan	VR display performance				
		Category	Micro	Display	Flat Par	el Display	
		Technology	LCoS	OLED ₀ S	TFT-LCD	AMO	
-	Specifications: Size: 5.5-inch diagonal Resolution: 3840 × 2160 PPI: 806 ppi Brightness: 350 nit Color gamut: 97% Pixel: RGB diamond PenTile	Size	< 1 inch	< 1 inch	> 1 inch	> 1	
		Resolution	< Full HD	< Full HD	< Quad HD	< Qu	
		PPI	< 2,500 ppi	< 2,500 ppi	< 500 ppi	< 60	
		Brightness	150 nit	150 nit	400 nit	40	
Press and a resulting of		Field of view	< 100	< 100	<120	<	
		Response time	> 10 µs	> 1 µs	> 10 µs	>	
THE REAL PROPERTY OF THE PARTY		Weight	< 7g	< 5g	< 30g	<	
Migh Resolution for VR		Thickness	< 5 mm	< 5 mm	< 2.0 mm	<1.	
ingritte sociation for the		Back light unit	Yes	No	Yes		
		Power consumption	< 350 mW	< 350 mW	< 700 mW	< 70	
Source: Samsung Display – Photo taken by IHS at SID 2016		Notes: All specifications are based on	commercialized products, not prototypes.				
server connectly engines - rivers terrer of a field of a forty	Source IHS						

© 2016 IHS

AMOLED > 1 inch < Quad HD < 600 ppi 400 nit < 120 > 1 µs < 30g <1.6 mm No < 700 mW



Display is the most high-price component in VR device

treel Connesseerre Ger ley ANOLTO 1621 easter 16 19 Soutom on Chia		Object Allebraid Cours Domainment Castell Convention Castel (Assemble / Insention / Test Castel)	5199.60 56.50		
Awo(ED 1x2) exect (Ce		Conversion Costs	66.00		
lay AMOLED (x2) aaster (Ca	Adventional Income				
lary ANACOLED (x2) easobr (Ca	and the second data and the se	Total Cost	\$206.10	Display cost = US\$69, 35% of th	e
Awo(ED 1x2) exect (Ce		(Direct materials and manufacturing) Construction	Total Cost		
easor ICs			559.00	total BOM (Bill of Materials) Cost	
RF Septem on Chip	SAMSUNG DISPLAY CO L D	51" Olagonal, AMOLEO, LTPS, 1200 + 1080, N/T, Perrille Matri	43 K		-
	NORDIC SEMICONDUCTO AS	A BF SoC, 2 You SP, Transceiver, 32-88: ARM Context-MD Core CP Plants, 10KB 8664, 8 You SP, 20 BH ADC, 31 (20)			
Microsontrolar	STANCROEDCTRONICS	MCO, 12-BH, ABM Cortex MD Care, Americ, szone mann 8, 16 Channel 12-BE ADC, R7 (JPIO).	CE NALANG 2-9		
Hanh	WINDOND ELECTRONICS C	P Flash, NOR, 63Mb, 5/5	60.64		
TPROM .	ST MICROEURCTRONICS ON SPMICONDUCTOR	FEPROM, 640b, DC Serial Interface FEPROM, 140s Serial	0125		
Interfere ICs Judio	C-MEDIA ELECTRONICS IN	USB Audio Controller, Single Chia, USB 2.0 Full Speed, w/ integ	67.94		
LED Driver (x3)	TEXAS INSTRUMENTS INC.	DAC & Headphone Amplifier, DC trite/Lace, E GPIDs			
UDD Driver (x0) UDD Hale Constructive	CYPRERA REMICONDUCTOR	LED Driver, 10-Channel, 12-88 Graphiale PWM Control, Serial H DRP USB Hish Controller, USB 1.0, 4-Pert, Integrated AtM Contex-M A Driver Series Controller, USB 1.0, 4-Pert, Integrated AtM Contex-M	D, TAKE KOM		
40MI-10-MIP Converter	TOSHIBA MEMICONDUCTOR	& 32KB ROM, sc/ Battery Charging, UC Interface Interface IC, HONDINI to MIPIRI Dual COI Conventer, HONI 1.4 Is	iput, Mohi Dist		
er Management Ka	2010/02/2020/02/2020/2020	4 lanes, Audio Output interface, GC Interface	\$2.58		
Hogulator (kit) Regulator	ANALOG DEVICES INC.	Regulator, DC OC Convertor, Mep-Bown, Adjustable, 1A, 1 7NP Regulator, LDO, -2 5V, -200mA, Low Nome		COM-	
Loud Switch (kT)	ON SEMICONDUCTOR	Load Switch, Integrated P-Channel MOSTET, 13A, w/ Auto-Disc	haige Path		
Regulator (x2) Regulator	TEXAS INSTRUMENTS INC. NEOH CO LTD	Regulator, DC-DC Converter Regulator, DC-DC Converter, Mep-Up, Adjustable, 700mA, 2.3N	INL w/ 33V		
Overvoltage Protection	MICON CD LTD	OVP Transhold Overvoltage Protection Switch, 29V, w/ Voltage Suppressor			
ers Kärntber (x44)	VISHWY INTERTECHNOLOGY		54.07		
Accelerameter / Gyrascope	BOSCH SENSORTEC GAMER	Oculus Rift Top Cost Drivers			
Microphone Positrolity Sensor	INCERTER INC	e caracterite representation		Provide Statistics (Statistics)	
. Destruction	104			Cost Summary	
iromashanizati				Direct Material Costs	\$199.60
heninels				(Component Costs)	
2 mm 2 22					46.50
ION				Conversion Costs	\$6.50
essor ICs ID System on Chip	MORDIC MEMICONDUCTOR A			(Assembly / Insertion / Test Costs)	
Webcam Controller	ETRON TECHNOLOGY INC			Total Cost	\$206.10
nary	10/00/02/2016/03/2016/				
EXPROM er Management Ka	ON SEMICONDUCTOR			(Direct materials and manufacturing)	
Regulator (x2) Regulator	ON SEMICOMPLICTOR BT MICROEUCTRONICS	Itemized Components	Manufacturer Name	Description	Total Cos
Regulator Overvoltage Protection	ST MICROELECTRONICS BICONI COLISD	HEADSET			
Carriera					400.00
- Electronics		Display			\$69.00
inemeshanicale		AMOLED (x2)	SAMSUNG DISPLAY CO LTD	3.51" Diagonal, AMOLED, LTPS, 1200 x 1080, N/T, Pentile Matrix, 12.2g	
handsala		Processor ICs			\$3.11
					90.11
1018		RF System-on-Chip	NORDIC SEMICONDUCTOR ASA	RF SoC, 2.4GHz RF Transceiver, 32-Bit ARM Cortex-M0 Core CPU, 128KB	
easor ICa It? System-os-Chip	NORDIC SEMICONDUCTOR A			Flash, 16KB RAM, 8-Channel 10-Bit ADC, 31 I/Os	
. Electronica		Microcontroller	ST MICROELECTRONICS	MCU, 32-Bit, ARM Cortex-MO Core, 48MHz, 128KB Flash & 16KB SRAM, 16-	
troinechanicals		and ocontroller	ST MICHOLLECTIONICS		
Namicals				Channel 12-Bit ADC, 87 GPIOs	

\$0.68 \$0.95

Misc. Accessories (Cables, Batteries, etc.) Uterature & Packaging



AMOLEDs From Emerging to Mainstream

Examples of Recent Prototypes and Commercialized AMOLEDs











LGE 77"



SDC Galaxy S6 LG G Watch

- LGD 18" Rollable

Apple Watch

Skyworth 65"



SDC 55" Transparent OLED 1920x1080, 45% transmittance



SDC 55" Mirror OLED 1920x1080, 75% reflectance



Hisense 65"



12.3" Samsung 2-in-1

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OLED for automotive applications Source: Makers, IHS



Dual-view curved tiling OLED

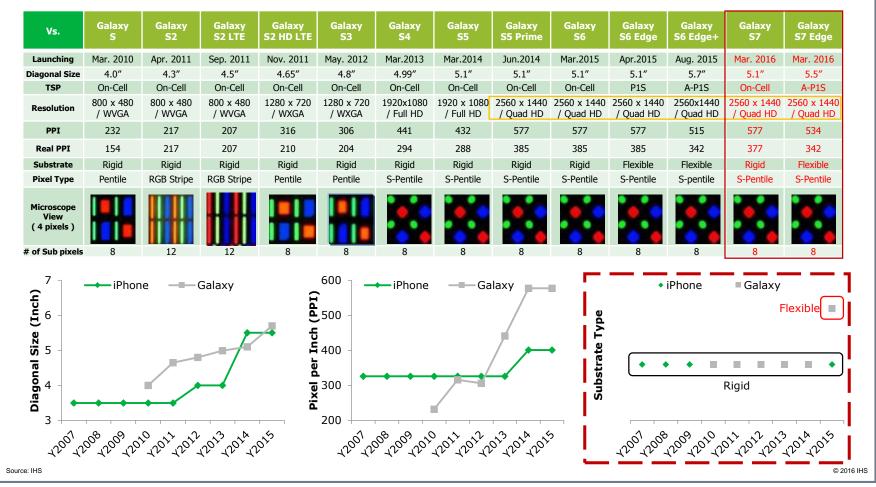


Dell 30" OLED Monitor



Technology Trend for Smartphone OLED

History of Galaxy S Series' AMOLED specification



⁽Source : IHS Report, 'OLED Strategy, Technology & Market - 2015')



OEMs increasing AMOLED panel adoption

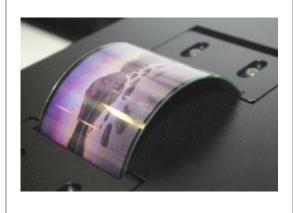
• Samsung's product lineup change and demand for Chines brands impact the AMOLED market growth.

Samsu	ng smartphon	e strategy in 2015-2016	Overseas brands' AMOLED smartphones				
	٨			2014	2015	2016	
	High end	Focus on flexible AMOLED to lead market and gain high profits	Model	21 models	over 50 models (55M panels)	over 50 models (100M panels)	
			Brand	Motorola, Nokia, Lenovo,	OPPO, VIVO, Gionee, Micromax,	OPPO, VIVO, Gionee, Micromax,	
	Mid end	Expand rigid AMOLED to grab the volume market		OPPO, VIVO, Gionee	Meizu, WIKO, Huawei, Microsoft,	Meizu , WIKO, Huawei , Xiaomi, Microsoft, BB, HP, Hisense, Konka	
			Product	High-end	Mid to high-end	Mid to high-end	
	Low end	Change displays from TFT LCD to AMOLED	Display	4.x-5.x"	4.x-6.0"	4.x-6.0"	
			Resolution	HD, FHD	HD, FHD, WQHD	HD, FHD, WQHD	
	Low end TFT LCD with add-on touch to meet low cost demand		Substrate	Rigid AMOLED	Rigid AMOLED Started to supply	Rigid AMOLED Increase flexible	
					flexible AMOLED from Q4 2015	AMOLED	
Source: IHS		© 2016 IHS	Source: IHS			© 2016 IHS	



Flexible OLED in SID 2016

JDI Curved 5.2" FHD



Source: IHS

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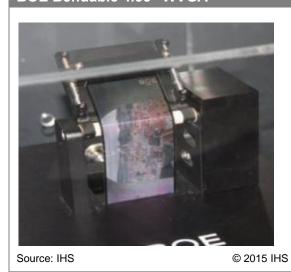


Source: IHS

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BOE Bendable 4.35" WVGA

LG Display Curved 12.3" FHD



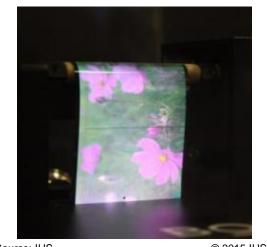
Tianma Bendable 5.5" FHD



Source: IHS

© 2015 IHS

BOE Foldable 4.35" WVGA



Source: IHS

Samsung Display Rollable 5.7" FHD

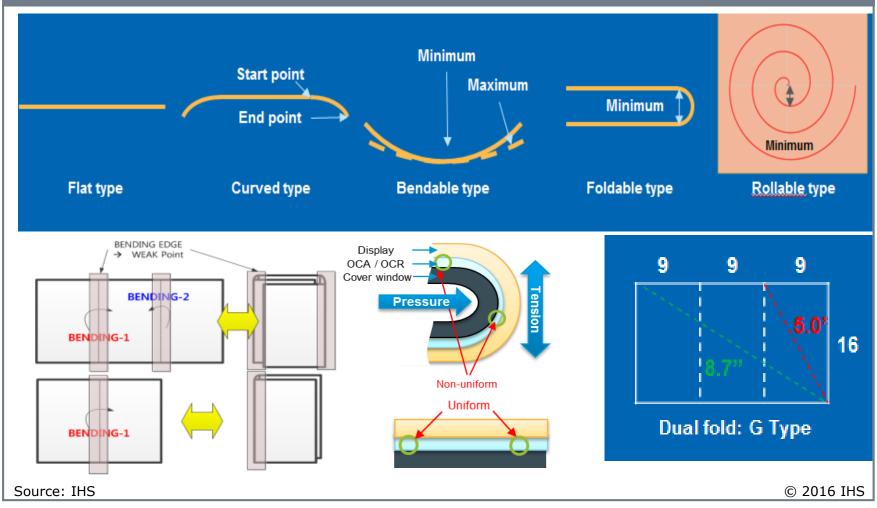


Source: IHS



Considering Foldable Application

Types of flexible display by bending radius and folds





Flexible OLED : Nice to Have or must have?

Nice but many substitutes good enough

No substitutes. Make people buy no matter how much it costs





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